

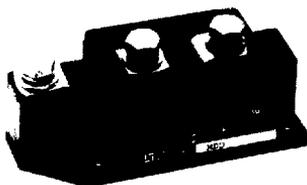


## Diode Modules

**MDD220**  $I_{TAV} = 2 \times 270 \text{ A}$

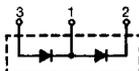
$V_{RRM} = 600\text{--}1600 \text{ V}$

$V_{RRM}$	$V_{RRM}$	Type	Threaded spacer for higher Anode/ Cathode construction: Type ZY 250, material brass
V	V	Version 1	
700	600	MDD220-06N1	
900	800	MDD220-08N1	
1300	1200	MDD220-12N1	
1500	1400	MDD220-14N1	
1700	1600	MDD220-16N1	



Symbol	Test conditions	Maximum Ratings
$I_{FRMS}$ $I_{FAVM}$	$T_{VJ}=T_{VM}$ $T_C=100^\circ\text{C}; (180^\circ\text{sin})$	450 270 A
$I_{FSM}$	$T_{VJ}=45^\circ\text{C}$ $V_R=0$	$t = 10 \text{ ms (50Hz)}$ 8500 A $t = 8.3 \text{ ms (60Hz)}$ 9000 A
	$T_{VJ}=T_{VM}$ $V_R=0$	$t = 10 \text{ ms (50Hz)}$ 7500 A $t = 8.3 \text{ ms (60Hz)}$ 8000 A
$IPdt$	$T_{VJ}=45^\circ\text{C}$ $V_R=0$	$t = 10 \text{ ms (50Hz)}$ 360000 A <sup>2</sup> s $t = 8.3 \text{ ms (60Hz)}$ 340000 A <sup>2</sup> s
	$T_{VJ}=T_{VM}$ $V_R=0$	$t = 10 \text{ ms (50Hz)}$ 280000 A <sup>2</sup> s $t = 8.3 \text{ ms (60Hz)}$ 260000 A <sup>2</sup> s
$T_{VJ}$		-40...+150 °C
$T_{VM}$		150 °C
$T_{stg}$		-40...+125 °C
$V_{ISOL}$	50Hz, RMS $I_{SO}=1\text{mA}$	$t = 1 \text{ min}$ 2500 V - $t = 1 \text{ s}$ 3000 V -
$M_d$	Mounting torque	2.5-5.0 Nm
	Terminal connection torque	12-15 Nm
Weight	typ. incl. screws	320 g

MDD220  
Version 1



### Features

- Glass passivated chips
- Direct copper bonded  $\text{Al}_2\text{O}_3$ -ceramic base plate
- Isolation voltage 2500 V (RMS)
- UL recognized, file no. E72873(M)
- International standard package, TO-240 AA

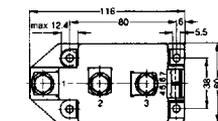
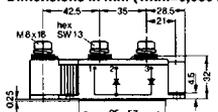
### Applications

- Supplies for DC power equipment
- DC supply for PWM inverter
- Field supply for DC motors
- Battery DC power supplies

### Advantages

- Space and weight savings
- Simple mounting
- Improved temperature and power cycling
- Reduced protection circuits

### Dimensions in mm (1mm=0,0094")



Symbol	Test conditions	Characteristic values
$i_R$	$T_{VJ}=T_{VM}; V_R=V_{RRM}$	$\leq 40 \text{ mA}$
$v_F$	$I_F=600\text{A}; T_{VJ}=25^\circ\text{C}$	$\leq 1.4 \text{ V}$
$V_{TO}$	For power-loss calculations only	0.75 V
$r_c$	$T_{VJ}=T_{VM}$	0.9 mΩ
$R_{thJC} \text{ (DC)}$	per thyristor(diode); DC current per module	$\leq 0.129 \text{ K/W}$
$R_{thJK} \text{ (DC)}$	per thyristor(diode); DC current per module	$\leq 0.065 \text{ K/W}$ $\leq 0.169 \text{ K/W}$ $\leq 0.0845 \text{ K/W}$
$Q_B$	$T_{VJ}=125^\circ\text{C}; I_F=400\text{A}; -di/dt=50\text{A}/\mu\text{s}$	$\leq 760 \mu\text{C}$
$I_{RM}$		$\leq 275 \text{ A}$
$d_B$	Creepage path	$\geq 12.7 \text{ mm}$
$d_A$	Strike	$\geq 9.6 \text{ mm}$

Standards: DIN/IEC 747-2

MDD220

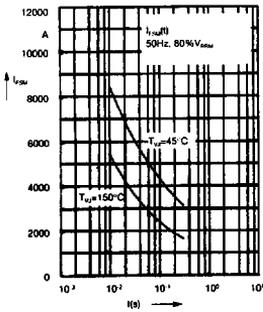


Fig. 1 Surge overload current  $I_{SM}$ : Crest value, t: duration

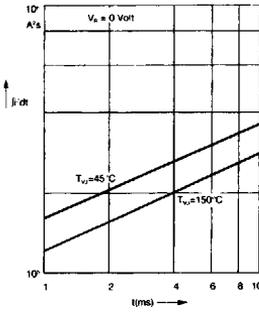


Fig. 2  $I^2Rt$  versus time (1-10ms)

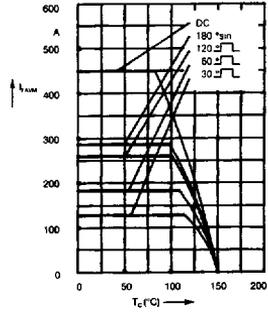


Fig. 2a Maximum forward current at case temperature

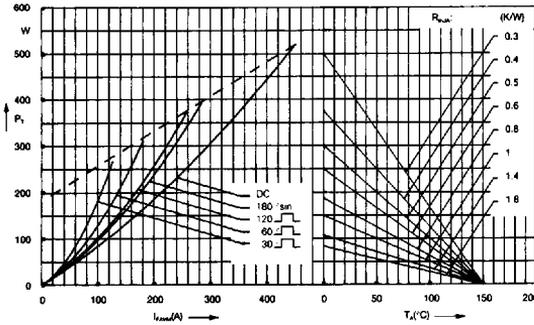


Fig. 3 Power dissipation versus forward current and ambient temperature (per diode)

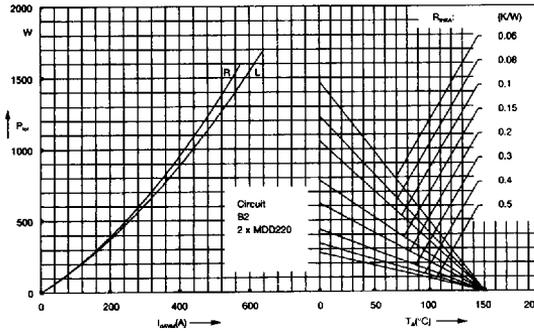


Fig. 4 Single phase rectifier bridge: Power dissipation versus direct output current and ambient temperature R=resistive load L=inductive load

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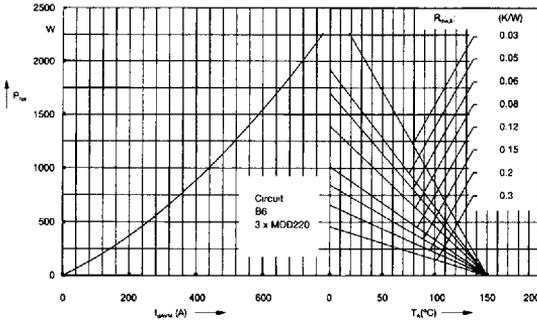


Fig. 5 Three phase rectifier bridge: Power dissipation versus direct output current and ambient temperature

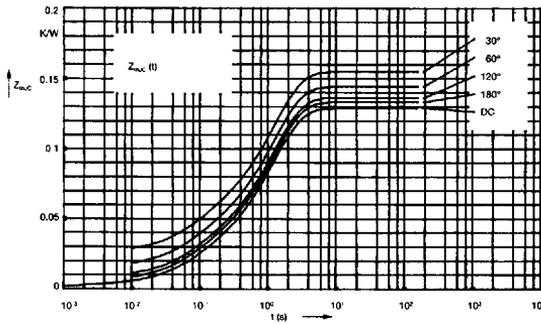


Fig. 6 Transient thermal impedance junction to case (per diode)

$R_{thJC}$  for various conduction angles d:

d	$R_{thJC}$ (K/W)
DC	0.129
180°	0.133
120°	0.136
60°	0.145
30°	0.159

Constants for  $Z_{thJC}$  calculation:

i	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.0026	0.00054
2	0.0201	0.099
3	0.1063	1.2

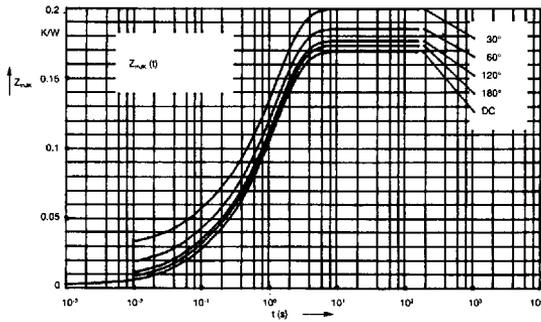


Fig. 7 Transient thermal impedance junction to heatsink (per diode)

$R_{thJK}$  for various conduction angles d:

d	$R_{thJK}$ (K/W)
DC	0.169
180°	0.173
120°	0.176
60°	0.185
30°	0.199

Constants for  $Z_{thJK}$  calculation:

i	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.0026	0.00054
2	0.0201	0.099
3	0.1063	1.20
4	0.04	1.25